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Part: IRFC23N15B

Description: 150 V Gen 5.3 HEXFET DIE ON WAFER

Support Docs: Datasheet

Specifications					
Parameter	Value				
Product Family	HB(FET				
Package	DIE ON WAFER				
Package Equivalent	IRFB23N15D				
Gen .	5.3				
Voltage	150				
Die Product	Die Product				

Packaging Options							
Product ID	Description	Status	Standard Pack	1 K Budgetary Pricing (USD)	Qty	-	
IRFC23N15B	150V Gen 5.3 HEXFET DIE ON WAFER	Active		8	1	ADD TO CART	

Package Support Docs

IR can offer a range of carrier options to suit individual customer needs. As standard, we offer probed Die on wafer, sawn Die on film and in waffle tray / chip pack.

For certain Die products, Tape and Reel, in the form of Pocket Tape is available. Please use our online help utility for details.

Details on the advantages/disadvantages of the various carrier options can be found in the application note on carrier options or the links above.



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